

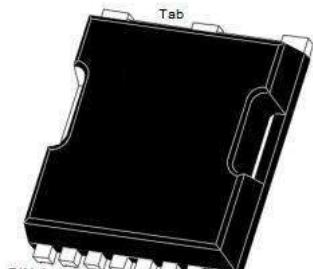
Features

- Uses MOT advanced double trench technology
- Low On-Resistance ($R_{DS(on)} \leq 22m\Omega$)
- Low Gate Charge
- Low Reverse transfer capacitances
- 100% avalanche tested
- Pb-free plating; RoHS compliant

Applications

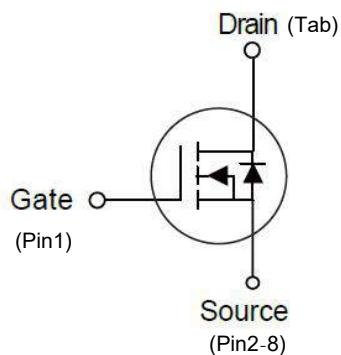
- Battery management
- Motor control and drive
- Synchronous rectification
- Switching applications

Pin configuration (Top view)



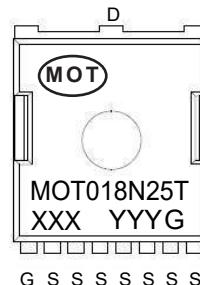
TOLL-8

Symbol



Key Performance Parameters

Parameter	Value	Unit
V_{DS}	250	V
$R_{DS(on)}$,typ.	19	$m\Omega$
I_D	90	A



Marking

Ordering information

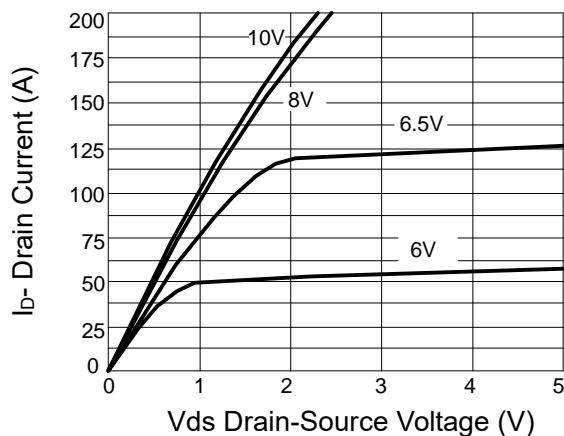
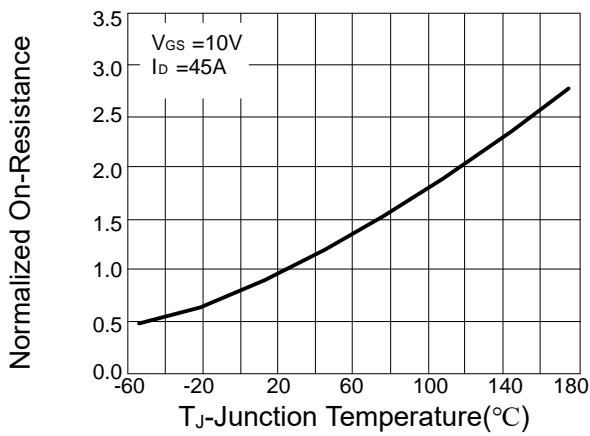
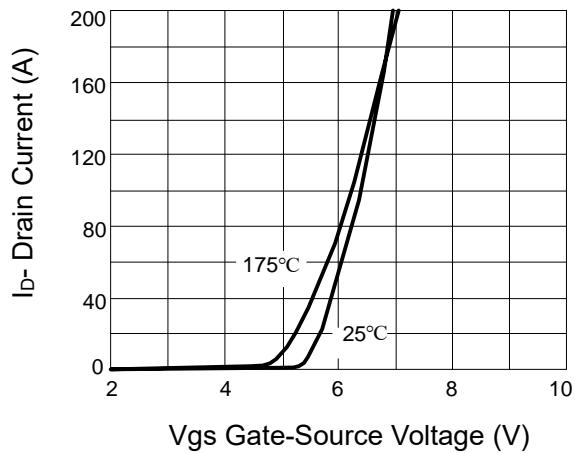
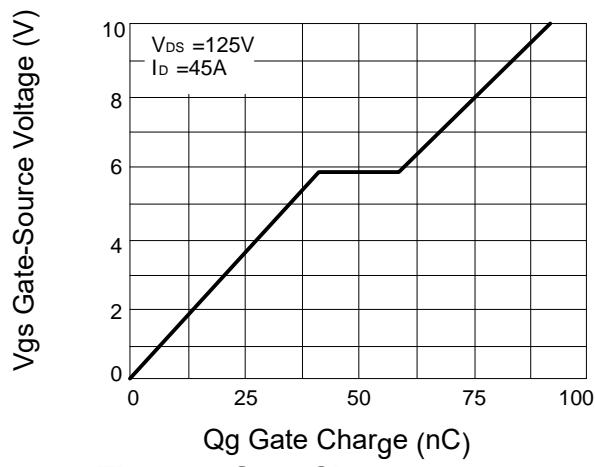
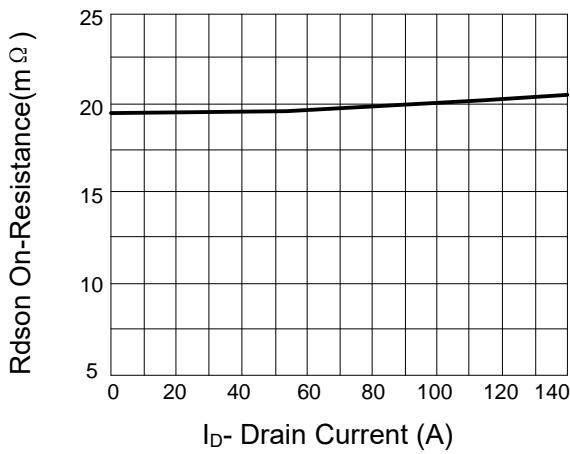
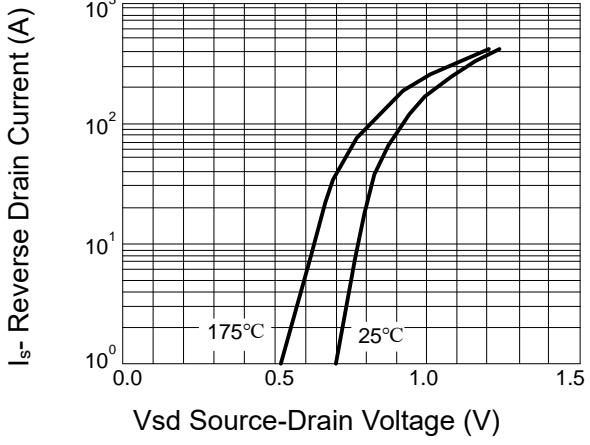
Type/Ordering Code	Package	Marking	Packing&Qty.(pcs)
MOT018N25T	TOLL-8	MOT018N25T	2000/Reel

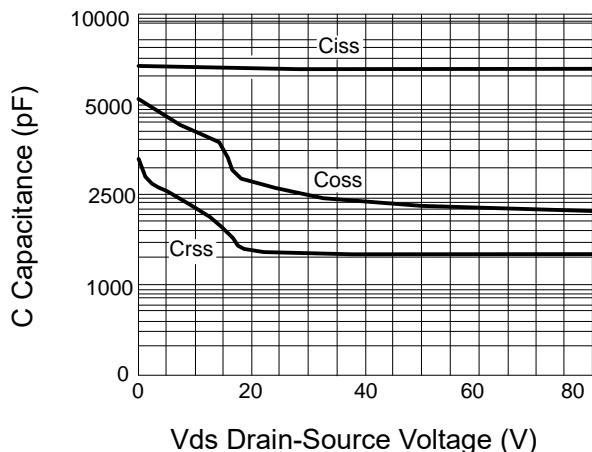
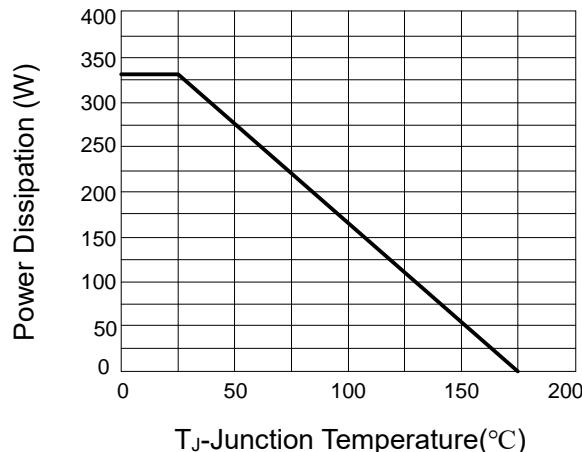
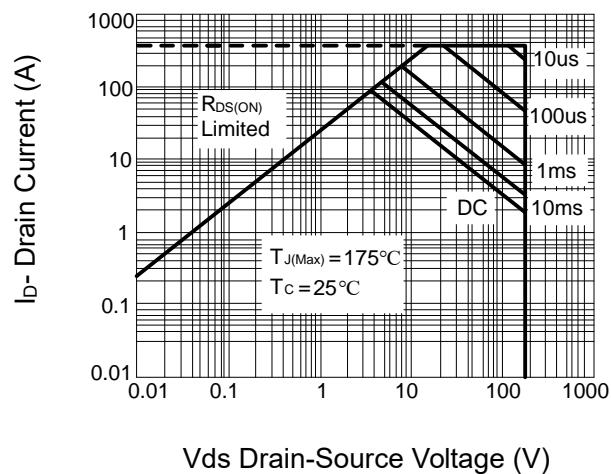
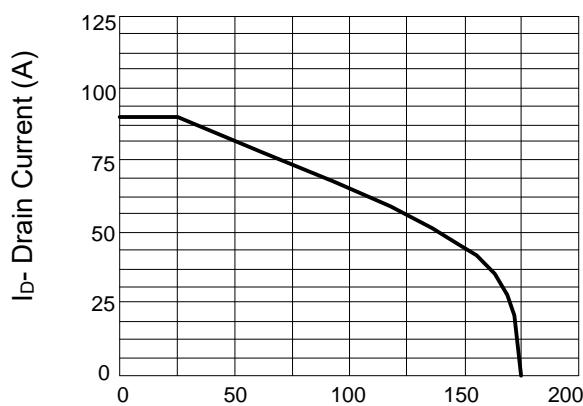
■ ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

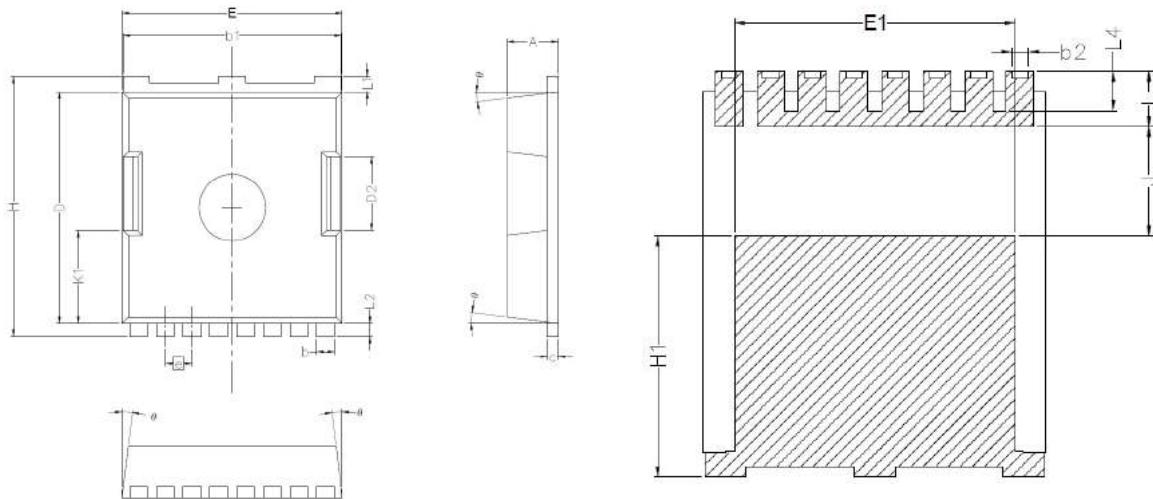
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	250	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	90	A
Drain Current-Continuous($T_C=100^\circ\text{C}$)	$I_D(100^\circ\text{C})$	63.6	A
Pulsed Drain Current	I_{DM}	360	A
Maximum Power Dissipation	P_D	330	W
Single pulse avalanche energy	E_{AS}	1700	mJ
Thermal Resistance,Junction-to-Case	$R_{\theta JC}$	0.45	$^\circ\text{C}/\text{W}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 175	$^\circ\text{C}$

■ ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$, unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	250	-	-	V
Zero Gate Voltage Drain Current	$I_{\text{DS}}^{\text{SS}}$	$V_{\text{DS}}=250\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
On characteristics						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0	-	4.0	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=45\text{A}$	-	19	22	$\text{m}\Omega$
Gate resistance	R_{G}		-	1.6	-	Ω
Forward Transconductance	g_{FS}	$V_{\text{DS}}=10\text{V}, I_{\text{D}}=5\text{A}$	10	-	-	S
Dynamic characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$	-	7000	-	PF
Output Capacitance	C_{oss}		-	2500	-	PF
Reverse Transfer Capacitance	C_{rss}		-	1700	-	PF
Switching characteristics						
Turn on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=125\text{V}, I_{\text{D}}=45\text{A}$ $V_{\text{GS}}=10\text{V}, R_{\text{G}}=4.7\Omega$	-	19.5	-	nS
Turn-on Rise Time	t_{r}		-	28	-	nS
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	48	-	nS
Turn-Off Fall Time	t_{f}		-	15	-	nS
Total Gate Charge	Q_{g}	$V_{\text{DS}}=125\text{V}, I_{\text{D}}=45\text{A}, V_{\text{GS}}=10\text{V}$	-	90.9	-	nC
Gate-Source Charge	Q_{gs}		-	40.4	-	nC
Gate-Drain Charge	Q_{gd}		-	18	-	nC
Drain-source diode characteristics						
Diode Forward Voltage	V_{SD}	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=90\text{A}$	-	-	1.2	V
Diode Forward Current	I_{S}		-	-	90	A
Reverse Recovery Time	t_{rr}	$T_J = 25^\circ\text{C}, I_F = 45\text{A}$ $dI/dt = 100\text{A}/\mu\text{s}$	-	186	-	nS
Reverse Recovery Charge	Q_{rr}		-	1.35	-	uC

■ TYPICAL CHARACTERISTICS

Figure 1 Output Characteristics

Figure 2 Rdson-JunctionTemperature

Figure 3 Transfer Characteristics

Figure 4 Gate Charge

Figure 5 Rdson- Drain Current

Figure 6 Source- Drain Diode Forward

■ TYPICAL CHARACTERISTICS(Cont.)

Figure 7 Capacitance vs Vds

Figure 8 Power De-rating

Figure 9 Safe Operation Area

Figure 10 Current De-rating

■ TOLL-8L PACKAGE OUTLINE DIMENSIONS


Symbol	Dimensions In Millimeters	
	Min.	Max.
A	2.20	2.40
b	0.70	0.90
b1	9.70	9.90
b2	0.42	0.50
c	0.40	0.60
D	10.28	10.58
D2	3.10	3.50
E	9.70	10.10
E1	7.90	8.30
e	1.20BSC	
H	11.48	11.88
H1	6.75	7.15
N	8	
J	3.00	3.30
K1	3.98	4.38
L	1.40	1.80
L1	0.60	0.80
L2	0.50	0.70
L4	1.00	1.30
θ	4°	10°

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